

ADC10D1000 Evaluation Board

Bench Evaluation Board

SPECIAL NOTES

These schematics reflect the current state of product development. This design had NOT yet been fully tested at the time these schematics were generated.


Since this product is in development, the user of this document is strongly advised to check for the latest revision.

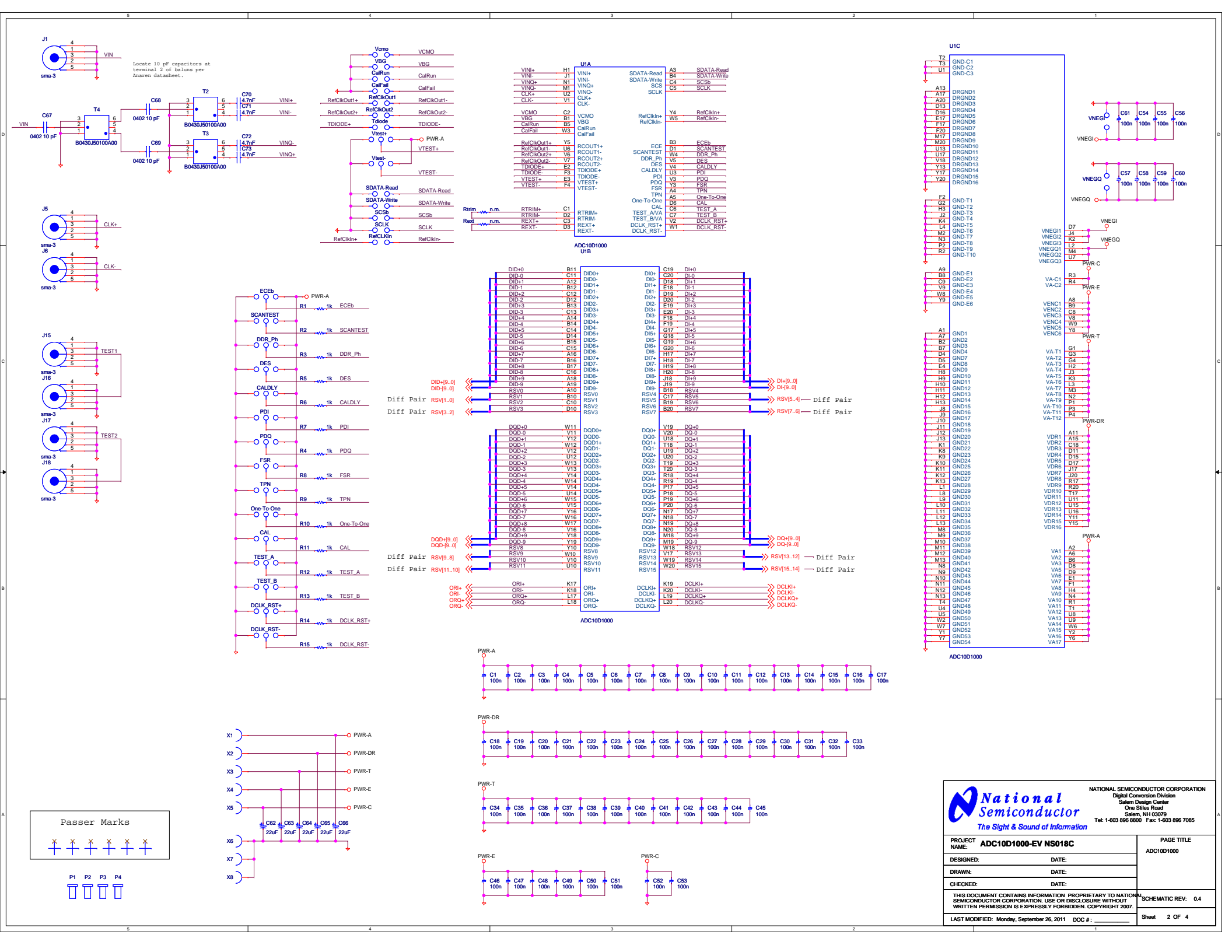
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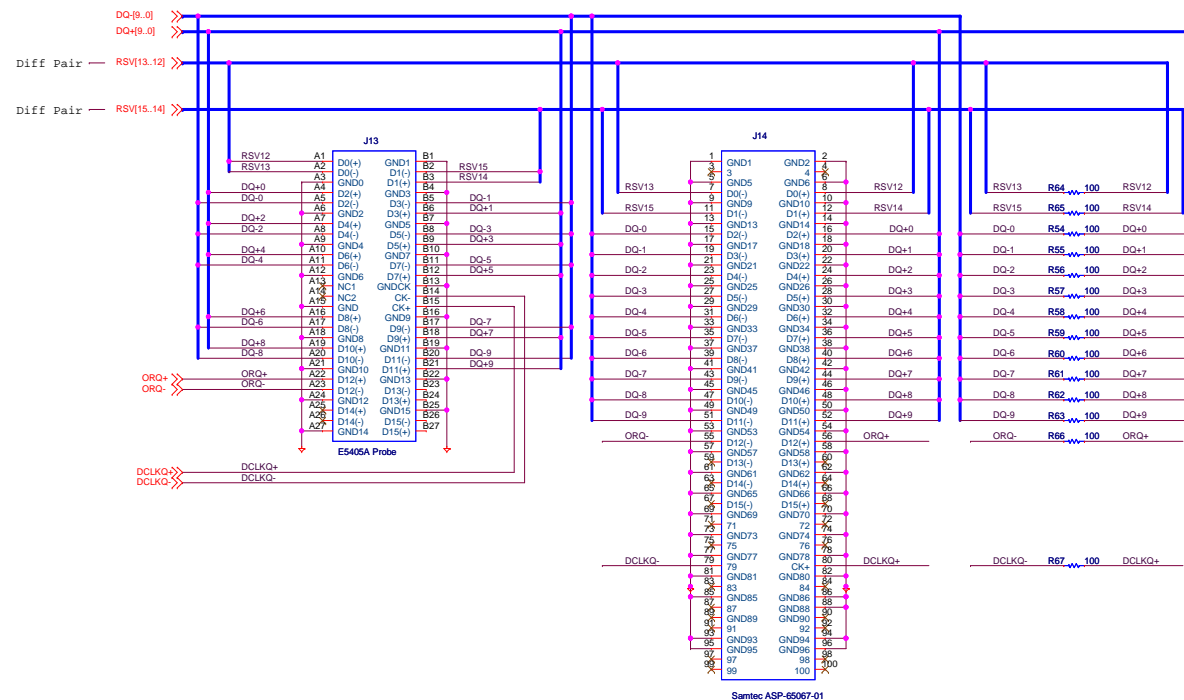
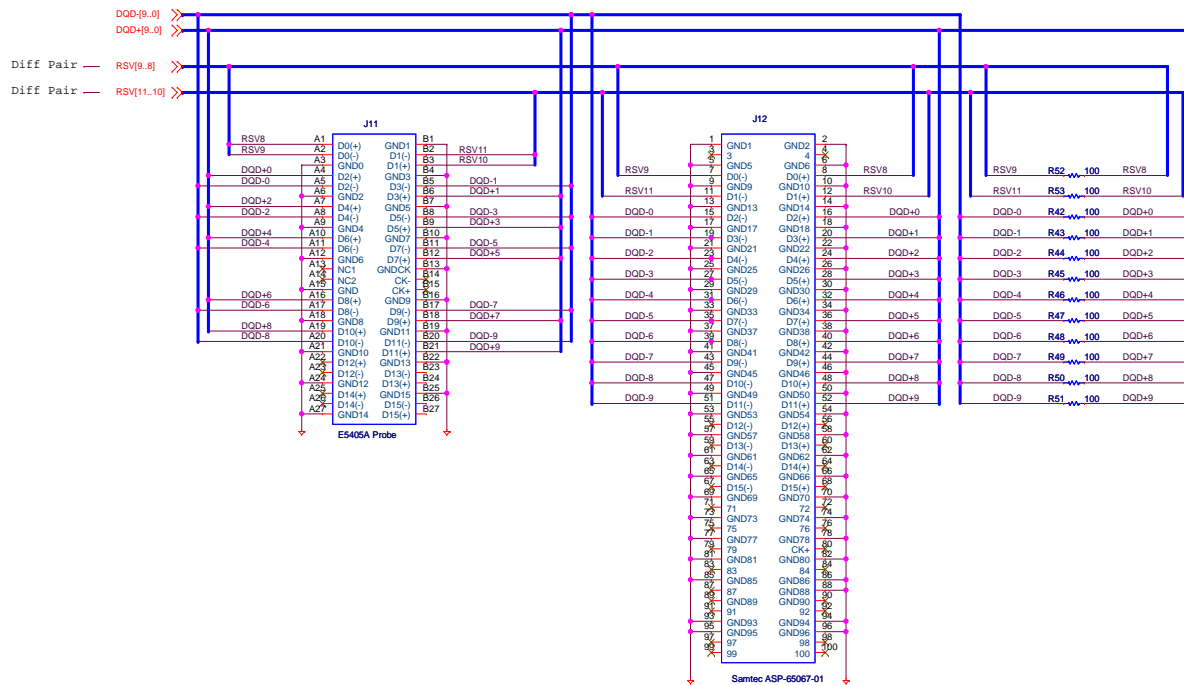
ALL parts labeled "NA" are NOT ASSEMBLED.

Print Instructions:

- To create a readable printout, we recommend to use A3 or 11x17" paper size.
- When printing from this PDF file, make sure to check the "Shrink to fit" box.

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